Electronic Patent Application Fee Transmittal								
Application Number:	10049270							
Filing Date:	27-Jun-2002							
Title of Invention:	MULTILAYER PRINTED WIRING BOARD, SOLDER RESIST COMPOSITION, METHOD FOR MANUFACTURING MULTILAYER PRINTED WIRING BOARD, AND SEMICONDUCTOR DEVICE							
First Named Inventor/Applicant Name:	Hui Zhong							
Filer:	Marvin Jay Spivak/Alexa Ann French							
Attorney Docket Number:	312302US40PCT							
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Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
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Patent-Appeals-and-Interference:								
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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